DATA SHEET

PCA8550

4-bit multiplexed/1-bit latched 5-bit I^{2}C EEPROM DIP switch

Product data
Supersedes data of 2001 Jan 12

2003 Jun 27

Philips Semiconductors

PHILIPS

4-bit multiplexed/1-bit latched 5-bit I²C EEPROM DIP switch

PCA8550

FEATURES

- 4-bit 2-to-1 multiplexer, 1-bit latch DIP switch
- 5-bit internal non-volatile register
- Override input forces all outputs to logic 0
- Internal non-volatile register write/readable via I²C-bus
- Write-protect pin enables/disables I²C writes to register
- 2.5 V multiplexed outputs
- 3.3 V non-multiplexed output (latched)
- 5 V tolerant inputs
- Useful for 'jumperless' configuration of PC motherboards
- Designed for use in Pentium Pro/Pentium II™ systems

DESCRIPTION

The primary function of the 4-bit 2-to-1 I²C multiplexer is to select either a 4-bit input or data from a non-volatile register and drive this value onto the output pins. One additional non-multiplexed register output is also provided. The non-multiplexed output is latched to prevent output value changes during I²C writes to the non-volatile register. A write protect input is provided to enable/disable the ability to write to the non-volatile register. An "override" input feature forces all outputs to logic 0.

PIN CONFIGURATION

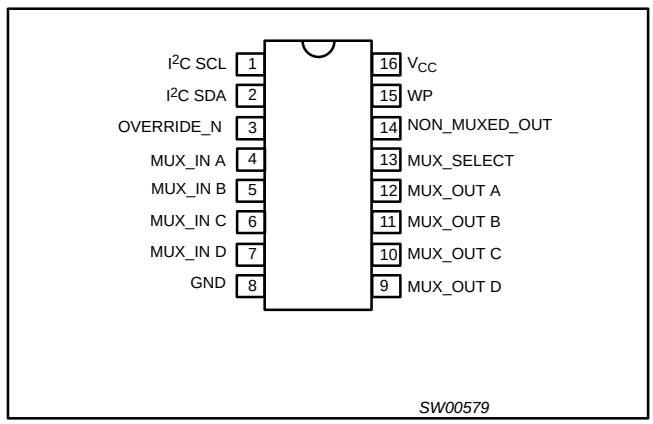

Figure 1. Pin configuration

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	TOPSIDE MARK	DRAWING NUMBER
16-Pin Plastic SO	0 to +70 °C	PCA8550D	PCA8550	SOT109-1
16-Pin Plastic SSOP	0 to +70 °C	PCA8550DB	PA8550	SOT338-1
16-Pin Plastic TSSOP	0 to +70 °C	PCA8550PW	PCA8550	SOT403-1

Standard packing quantities and other packaging data is available at www.philipslogic.com/packaging.

FUNCTIONAL DESCRIPTION

When the MUX_SELECT signal is logic 0, the multiplexer will select the data from the non-volatile register to drive on the MUX_OUT pins. When the MUX_SELECT signal is logic 1, the multiplexer will select the MUX_IN lines to drive on the MUX_OUT pins. The MUX_SELECT signal is also used to latch the NON_MUXED_OUT signal which outputs data from the non-volatile register. The NON_MUXED_OUT signal latch is transparent when MUX_SELECT is in a logic 0 state, and will latch data when MUX_SELECT is in a logic 1 state. When the active-LOW OVERRIDE_N signal is set to logic 0 and the MUX_SELECT signal is at a logic 0, all outputs will be driven to logic 0. This information is summarized in Table 1.

The write protect (WP) input is used to control the ability to write the contents of the 5-bit non-volatile register. If the WP signal is logic 0, the I²C-bus will be able to write the contents of the non-volatile register. If the WP signal is logic 1, data will not be allowed to be written into the non-volatile register.

The factory default for the contents of the non-volatile register are all logic 0. These stored values can be read or written using the I²C bus (described in the next section).

The OVERRIDE_N, WP, MUX_IN, and MUX_SELECT signals have internal pull-up resistors. See the DC and AC Characteristics for hysteresis and signal spike suppression figures.

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PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1	I²C SCL	I²C-bus clock
2	I²C SDA	Bi-directional I²C-bus data
3	OVERRIDE_N	Forces all outputs to logic 0
4	MUX_IN A	External inputs to multiplexer
5	MUX_IN B	
6	MUX_IN C	
7	MUX_IN D	
8	GND	Common ground voltage rail
9	MUX_OUT D	2.5 V multiplexed output
10	MUX_OUT C	
11	MUX_OUT B	
12	MUX_OUT A	
13	MUX_SELECT	Selects MUX_IN inputs or register contents for MUX_OUT outputs
14	NON_MUXED_OUT	TTL-level output from non-volatile memory
15	WP	Non-volatile register write-protect
16	V_{CC}	Positive voltage rail

FUNCTION TABLE

Table 1. Function table

OVERRIDE_N	MUX_SELECT	MUX_OUT OUTPUTS	NON_MUXED_OUT OUTPUT
0	0	All 0's	All 0's
0	1	MUX_IN inputs	Latched NON_MUXED_OUT[1]
1	0	From non-volatile register	From non-volatile register
1	1	MUX_IN inputs	From non-volatile register

NOTE

1. Latched NON_MIXED_OUT state will be the value present on the NON_MUXED_OUT output at the time of the MUX_SELECT input transitioned from a logic 0 to a logic 1 state.

I²C INTERFACE

Communicating with this device is initiated by sending a valid address on the I²C-bus. The address format (see FIgure 2) is a fixed unique 7-bit value followed by a 1-bit read/write value which determines the direction of the data transfer.

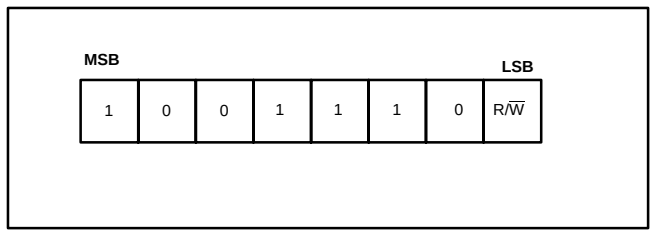


Figure 2. I²C Address Byte

Following the address and acknowledge bit are 8 data bits which, depending on the read/write bit in the address, will read data from or write data to the non-volatile register. Data will be written to the register if the read/write bit is logic 0 and the WP input is logic 0. Data will be read from the register if the bit is logic 1. The three high-order bits (see FIgure 3) are logic 0. The next bit is data which is non-multiplexed. The low four bits are the data which will be multiplexed. A write with any of the first three bits non-zero will be aborted.

NOTE:

1. To ensure data integrity, the non-volatile register must be internally write protected when V_{CC} to the I²C-bus is powered down or V_{CC} to the component is dropped below normal operating levels.

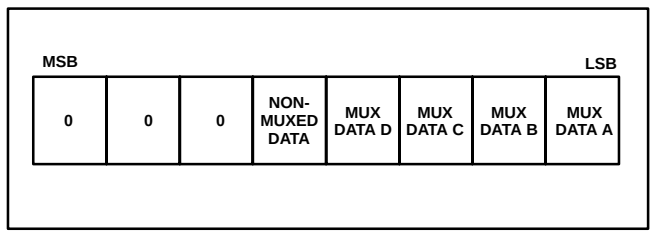


Figure 3. I²C Data Byte

POWER-ON RESET (POR)

When power is applied to V_{CC}, an internal power-on reset holds the PCA8550 in a reset state until V_{CC} has reached V_{POR}. At that point, the reset condition is released and the PCA8550 volatile registers and I²C state machine will initialize to their default states.

The MUX_OUT and NON_MUXED_OUT pin values depend on:

- the OVERRIDE_N and MUX_SELECT logic levels
- the previously stored values in the EEPROM register/current MUX_IN pin values as shown in Table 1.

BLOCK DIAGRAM

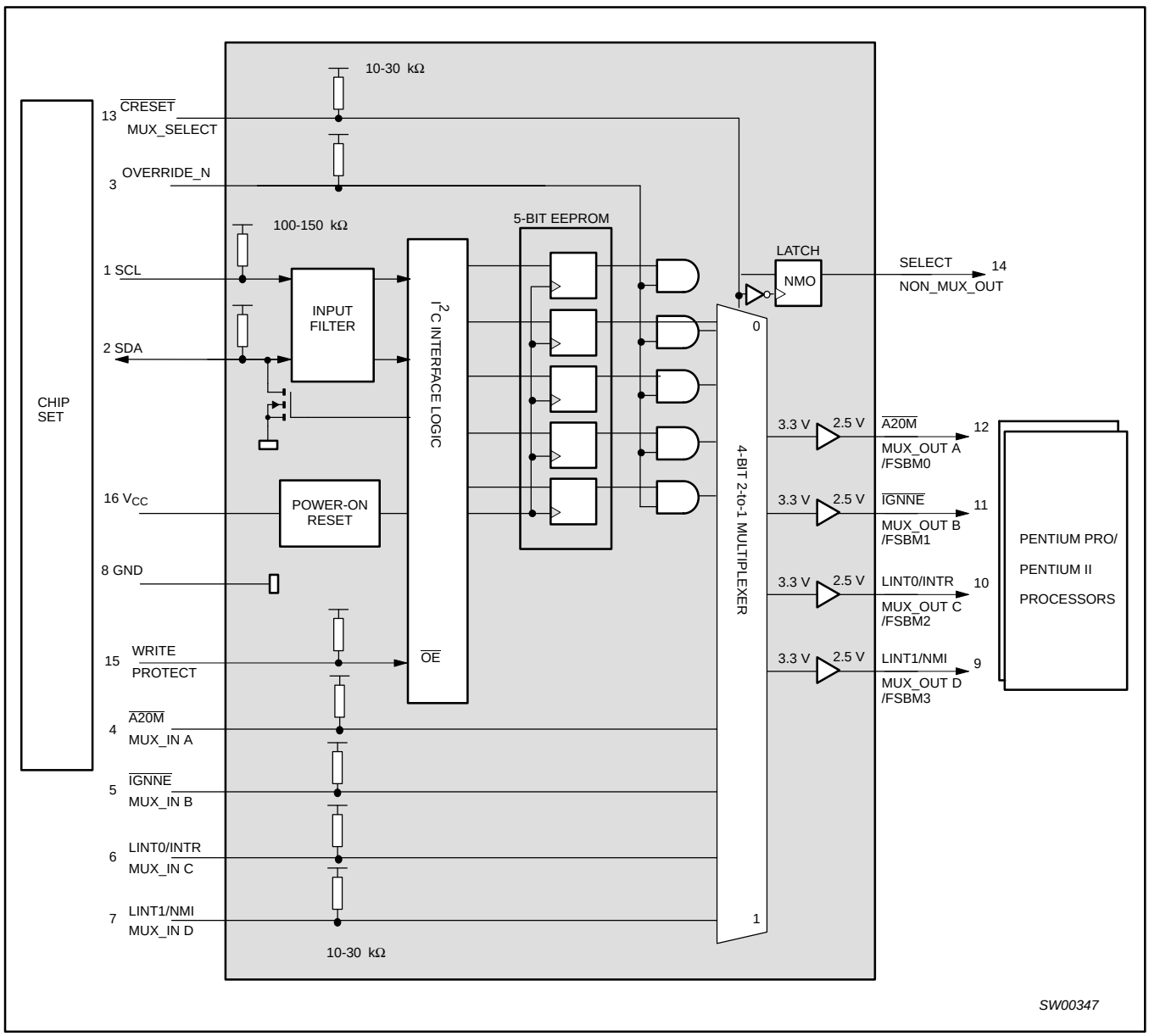


Figure 4. Block diagram

ABSOLUTE MAXIMUM RATINGS[1, 2]

In accordance with the Absolute Maximum Rating System (IEC 134)
Voltages are referenced to GND (ground = 0 V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		-0.5 to +4.6	V
V_I	DC input voltage	Note 3	-1.5 to V_{CC} +1.5	V
V_{OUT}	DC output voltage	Note 3	-0.5 to V_{CC} +0.5	V
T_{stg}	Storage temperature range		-60 to +150	°C

NOTES:
1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.
3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		CONDITIONS	LIMITS		UNIT
				MIN	MAX	
V_{CC}	DC supply voltage			3.0	3.6	V
V_{POR}	Power-on reset voltage		No load; $V_I = V_{DD}$ or GND	—	2.6	V
V_{IL}	LOW-level input voltage	SCL, SDA	I_{OL}= 3 mA	-0.5	0.9	V
V_{IH}	HIGH-level input voltage	SCL, SDA	I_{OL}= 3 mA	2.7	4.0	V
V_{OL}	LOW-level output voltage	SCL, SDA	I_{OL}= 3 mA	—	0.4	V
V_{IL}	LOW-level input voltage	OVERRIDE_N, MUX_IN, MUX_SELECT		-0.5	0.8	V
V_{IH}	HIGH-level input voltage	OVERRIDE_N, MUX_IN, MUX_SELECT		2.0	4.0	V
I_{OL}	LOW-level output current	MUX_OUT NON_MUXED_OUT		—	2.0	mA
I_{OH}	HIGH-level output current	MUX_OUT NON_MUXED_OUT		—	-2.0	mA
dt/dv	Input transition rise or fall time			0	10	ns/V
T_{amb}	Operating ambient temperature			0	70	°C

DC CHARACTERISTICS

Temp = 0 to +70 °C 3.0 V < V_{CC} ≤ 3.6 V

SYMBOL	PARAMETER	CONDITIONS	LIMITS		UNIT
			MIN	MAX	
SCL, SDA					
V_{OL}	LOW-level output voltage		0	0.6	V
I_{OL}	LOW-level output current	V_{OL} = 0.4 V		3.0	mA
I_{OL}	LOW-level output current	V_{OL} = 0.6 V		6.0	mA
I_{IL}[1]	LOW-level input current	V_{IL} = 0.4 V	-7	-32	µA
I_{IH}	HIGH-level input current	V_{IH} = 2.4 V	-1.5	-12	µA
V_{hys}	Hysteresis voltage		0.19		V
OVERRIDE_N, WP, MUX_SELECT					
I_{IL}	LOW-level input current		-86	-267	µA
I_{IH}	HIGH-level input current		-20	-100	µA
MUX_IN A ⇒ D					
I_{IL}	LOW-level input current	V_{IL} = 0.4 V	-0.72	-2.0	mA
I_{IH}	HIGH-level input current	V_{IH} = 2.4 V	-0.72	-2.0	mA
MUX_OUT					
V_{OL}	LOW-level output voltage	I_{OL} = 100 µA	-0.3	0.4	V
		I_{OL} = 2.0 mA	-0.3	0.7	
V_{OH}	HIGH-level output voltage	I_{OH} = -100 µA	2.0	2.625	V
		I_{OH} = -1.0 mA	1.7	2.625	
NON_MUXED_OUT					
V_{OL}	LOW-level output voltage	I_{OL} = 100 µA	-0.5	0.4	V
		I_{OL} = 2.0 mA	-0.5	0.7	
V_{OH}	HIGH-level output voltage	I_{OH} = -100 µA	2.4	3.6	V
		I_{OH} = -2.0 mA	2.0	3.6	
I_{CC}	Quiescent supply current	V_{CC} = 3.3 V; V_I = 0 V to V_{CC}		10	mA
I_{CC}	Quiescent supply current	V_I = V_{CC}		500	µA
C_I	Input capacitance			10	pF
	ESD protection		2.0		KV
	Input diode clamp voltage		-1.5		V

NOTES:
1. V_{HYS} is the hysteresis of Schmitt-Trigger inputs
2. Human body model

NON-VOLATILE STORAGE SPECIFICATIONS

Parameter	Specification
Memory cell data retention	10 years min
Number of memory cell write cycles	100,000 cycles min

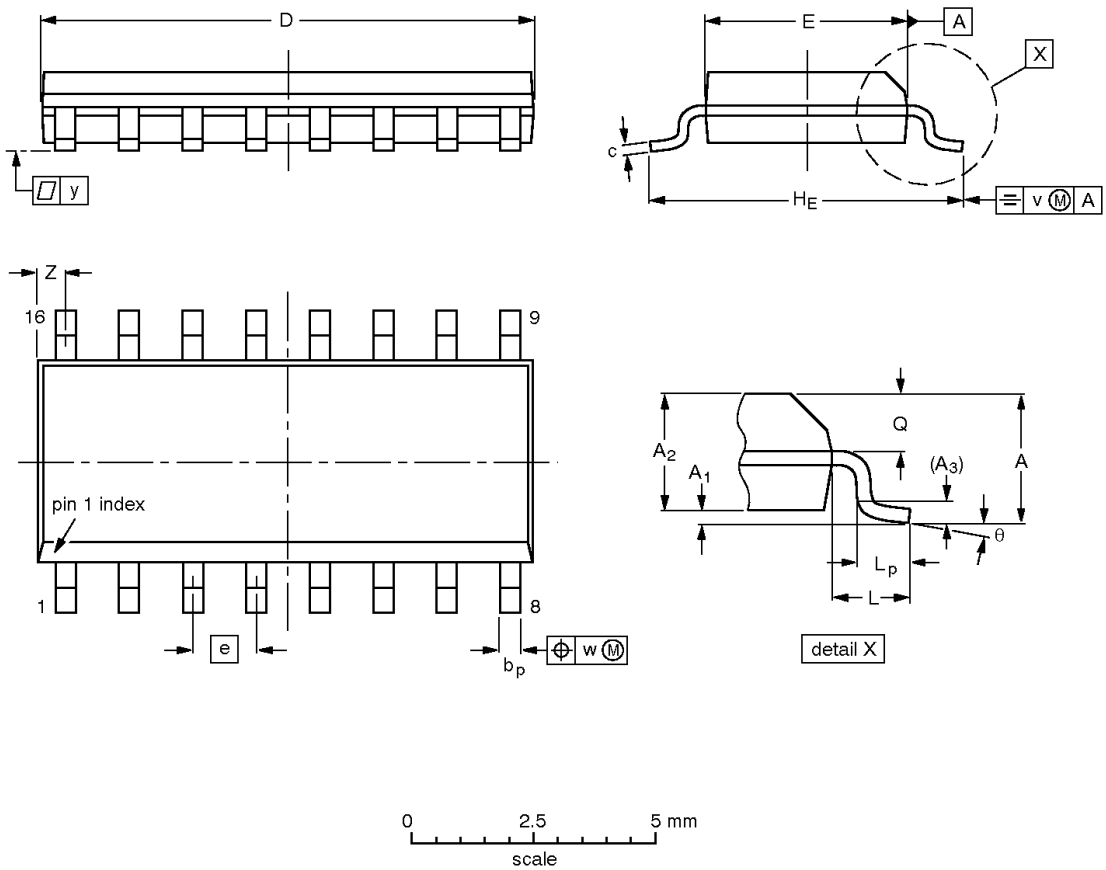
Application Note *AN250 I²C DIP Switch* provides additional information on memory cell data retention and the minimum number of write cycles.

AC CHARACTERISTICS

SYMBOL	PARAMETER	LIMITS		UNIT
		MIN	MAX	
t_{MPD}	Mux input to output propagation delay		20.0	ns
t_{SOV}	MUX_SELECT to output valid		22	ns
t_{OVN}	OVERRIDE_N to NON_MUX output delay		15.0	ns
t_{OVM}	OVERRIDE_N to mux output delay		25.0	ns
t_R	Output rise time	1.0	3.0	ns/V
t_F	Output fall time	1.0	3.0	ns/V
C_L	Test load capacitance on Muxed/Non-Muxed outputs		15	pF
I²C-bus				
f_{SCL}	I²C clock frequency	10	400	KHz
t_{SCH}	I²C clock HIGH time	600		ns
t_{SCL}	I²C clock LOW time	1.3		ns
t_{DSP}	I²C data spike time	0	50	ns
t_{SDS}	I²C data set-up time	100		ns
t_{SDH}	I²C data hold time	0		ns
t_{ICR}	I²C input rise time (10-400 pF bus)	20	300	ns
t_{ICF}	I²C input fall time (10-400 pF bus)	20	300	ns
t_{BUF}	I²C-bus free time between start and stop	1.3		ns
t_{STS}	I²C repeated start condition set-up	600		ns
t_{STH}	I²C repeated start condition hold	600		ns
t_{SPS}	I²C stop condition set-up	600		ns
C_B	I²C-bus capacitive load		400	pF
T_W	Write cycle time[1]	TYPICAL = 15		ms

NOTE:
1. WRITE CYCLE time can only be measured indirectly during write cycle. The device will not acknowledge its I²C address.

SO16: plastic small outline package; 16 leads; body width 3.9 mm **SOT109-1**



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

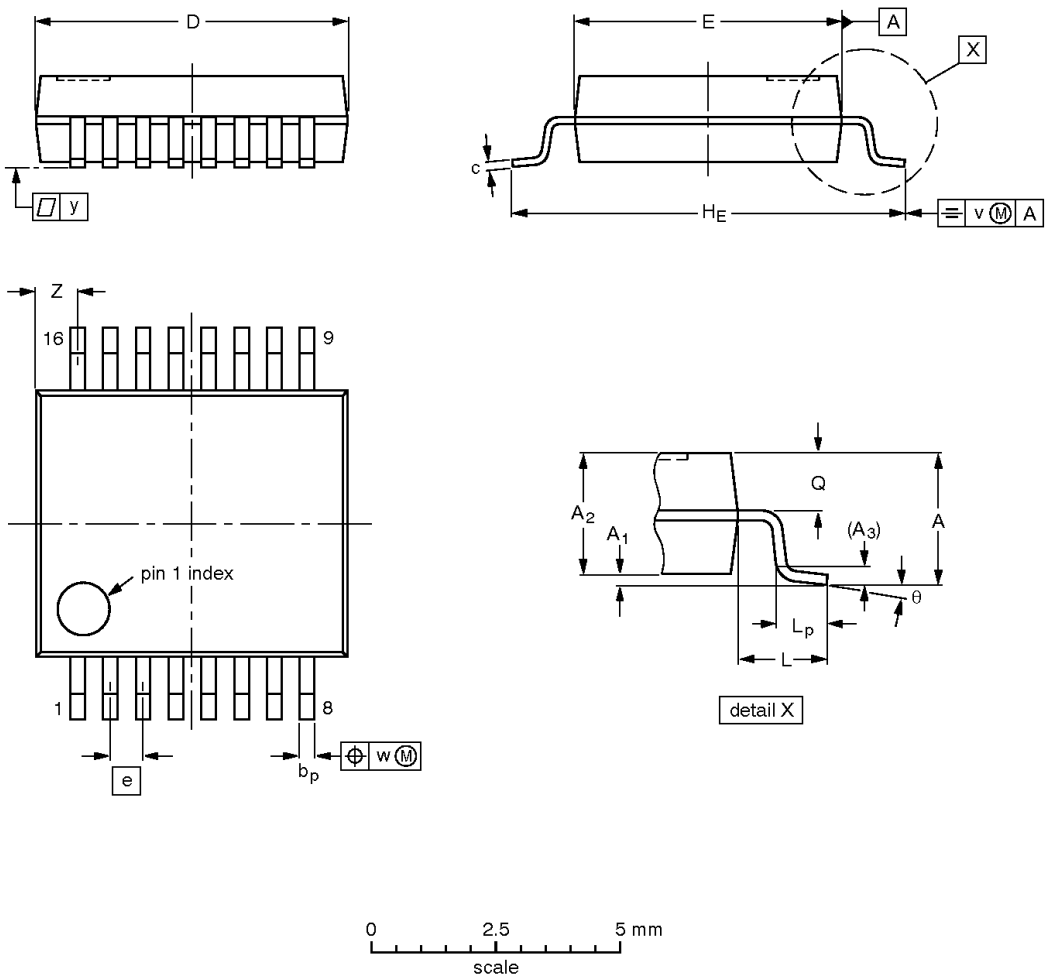
UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8^o 0^o
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.39 0.38	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT109-1	076E07	MS-012				~~97-05-22~~ 99-12-27

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm **SOT338-1**



DIMENSIONS (mm are the original dimensions)

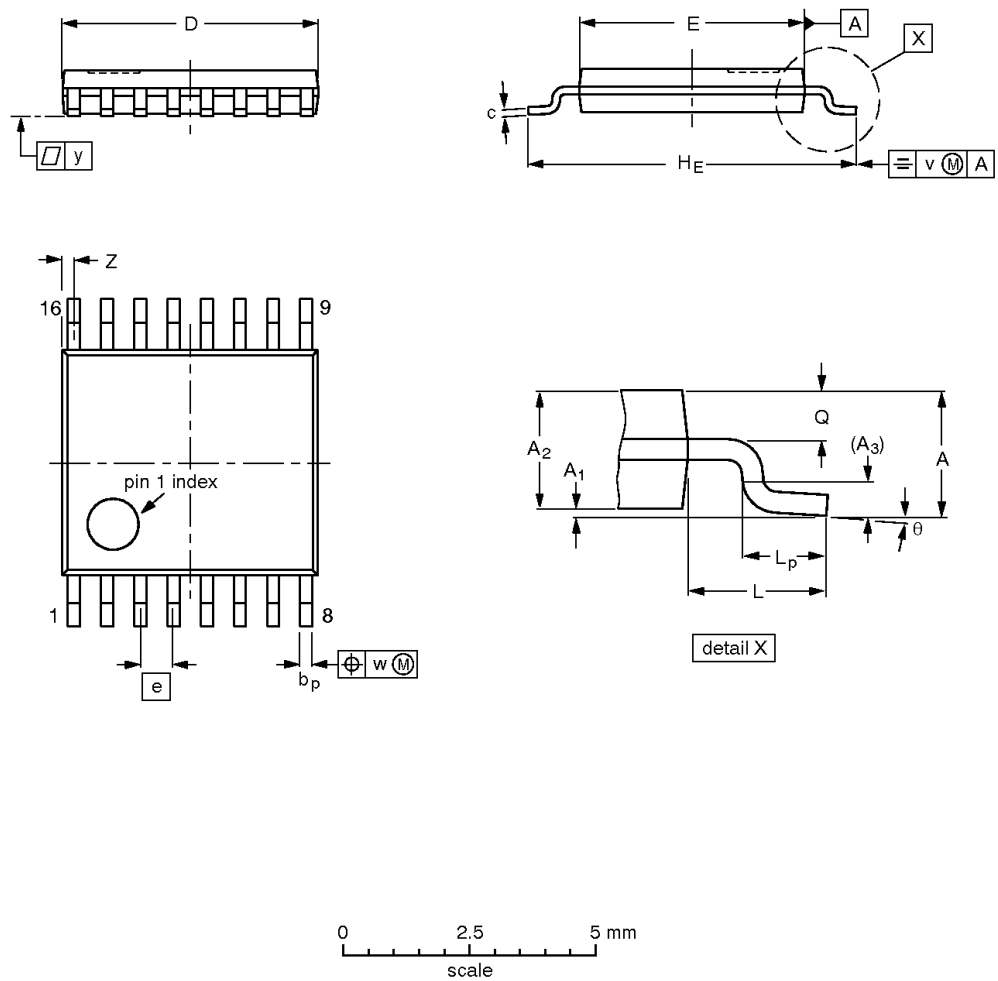
UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (1)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT338-1		MO-150				~~95-02-04~~ 99-12-27

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm **SOT403-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (2)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8^o 0^o

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

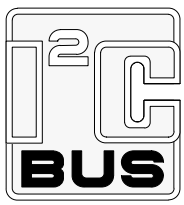
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT403-1		MO-153				~~95-04-04~~ 99-12-27

REVISION HISTORY

Rev	Date	Description
_6	20030627	**Product data (9397 750 11678); ECN 853-2015 29936 dated 19 May 2003. Supersedes data of 2001 Jan 12 (9397 750 07926).** Modifications: • Update marketing information. • Increase number of write cycles from 3K to 100K.
_5	20010112	Product data (9397 750 07926); ECN 853-2015 25405 of 12 Jan 2001.

4-bit multiplexed/1-bit latched 5-bit I²C EEPROM DIP switch

PCA8550



Purchase of Philips I²C components conveys a license under the Philips' I²C patent to use the components in the I²C system provided the system conforms to the I²C specifications defined by Philips. This specification can be ordered using the code 9398 393 40011.

Data sheet status

Level	Data sheet status[1]	Product status[2] [3]	Definitions
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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